

FACULTÉ DES SCIENCES



# Tape performance specification and performance vs. production

**Carmine SENATORE, Romain BABOUCHE, Celia LUCAS, Marco BONURA, Damien ZURMUEHLE** 



Tatsunori OKADA, Yuji TSUCHIYA, Satoshi AWAJI

High Field Laboratory for Superconducting Materials, University of Tohoku, Japan

Gianluca VERNASSA, Bernardo BORDINI, Luca BOTTURA



CERN, Switzerland

# Outline

- A short introduction to the Muon Collider magnets
- MuCol procurement of REBCO coated conductors
  - Conductor specs for the HF and UHF solenoids
  - Transport I<sub>c</sub> measurements and scaling relations
  - Results of the measurement campaign on the angular dependence of I<sub>c</sub>
  - Delamination strength under I x B force
- Conclusions

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### The zoo of REBCO magnets for a high-energy muon collider



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#### **HTS technical specs for MuCol solenoids R&D**

| European<br>Organisat                     | n Organization for Nuclear Research |  |          | Specification | Target  |
|---|-------------------------------------|--|----------|---------------|---------|
|   | modern REBCO tapes                  | Minimum I <sub>c</sub> /width (4.2 K, 20 T)                    | (A/cm)   | 600           | 1200    |
| No. 2960999                               | exceed these specs                  | Benchmark I <sub>c</sub> /width (4.2 K, 5 T)                   | (A/cm)   | 1440          |         |
|   |                                     | Minimum n value  | (-)      | 15            |         |
|   |                                     | σ(I <sub>c</sub> (4.2 K, 20 T))                                | (%)      |               | 5       |
|   | Price Enquiry                       | Minimum J <sub>non-Cu</sub> (4.2 K, 20 T)                      | (A/mm²)  |               | 3000    |
|   | <b>Technical Specification</b>      | Minimum J <sub>non-Cu</sub> (20 K, 20 T)                       | (A/mm²)  |               | 1200    |
| Su  | upply of REBCO Coated Conductor     | Unit length UL   | (m)      | 200           | 1000    |
|   | for                                 | Minimum bending radius   | (mm)     | 10            | 5       |
|   | Muon Collider Solenoids R&D         | Allowable non-Cu $\sigma_{\text{longitudinal non-Cu}}$ (4.2 K) | (MPa)    | 800           | 1000    |
|   | Mechanics in UHF HTS solenoids is   | Allowable compressive $\sigma_{transverse}$ (4.2 K)            | (MPa)    | 300           | 600     |
| This Tea<br>REBCO<br>Delivery<br>Contract | challenging. Few data on the        | Allowable tensile $\sigma_{transverse}$ (4.2 K)                | (MPa)    | > 5           | 50      |
|   | conductors make hard to give good   | Allowable shear $\tau_{transverse}$ (4.2 K)                    | (MPa)    | > 5           | 50      |
|   | values for some specs               | Range of allowable ε <sub>longitudinal</sub>                   | (%)      | -0.10.4       | -0.10.5 |
|   |                                     | Internal specific resistance $\rho_{transverse}$               | (nΩ/cm²) |               | 20      |

Procurement of 4 mm tape for R&D windings at W FARADAY FACTORY 《上海超导》 FUjikura



Total 11 km of REBCO tape in house at CERN from 5 worldwide producers

|  | Width | REBCO Type | REBCO<br>Thickness | Deposition<br>Method            | Pinning Type                | Hastelloy<br>Thickness | Cu Stabilizer                | I <sub>c</sub> (77K,s.f.) |            |   |       |                  |          |
|--|-------|------------|--------------------|---------------------------------|-----------------------------|------------------------|------------------------------|---------------------------|------------|---|-------|------------------|----------|
|  |       |            |                    | 5 μm IBAD/PLD BHO columns 50 μr |                             |                        | 2 x 40 μm<br>electroplated   | 420 A/cm                  |            |   |       |                  |          |
|  | 4 mm  |            |                    |                                 |                             | -                      | 2 x 20 μm<br>electroplated   | 380 A/cm                  |            |   |       |                  |          |
| 🗲 Fujikura                                   |       | EuBCO      | <b>2.5</b> μm      |                                 | <b>50</b> μm                | 2 x 10 um              | ▲ 650 A/cm                   |                           |            |   |       |                  |          |
|  |       |            | •                  |                                 | (artificial)                |                        | 2 X IU µIII                  | 558 A/cm                  |            |   |       |                  |          |
|  |       | _          |                    |                                 |                             |                        | electroplated                | 515 A/cm                  |            |   |       |                  |          |
|  | 2 mm  |            |                    |                                 |                             |                        | 2 x 20 μm<br>electroplated   | 555 A/cm                  |            |   |       |                  |          |
|  |       |            | <b>▲ 3.1</b> μm    |                                 |                             | <b>▲</b> 100 μm        | 2 x 20 μm<br>electroplated   | 550 A/cm                  |            |   |       |                  |          |
| // <b>F</b> FARADAY                          | 4 mm  | 4 mm       | 4 mm               | 4 mm                            | 4 mm                        | 4 mm                   | VPCO                         | <b>2.7</b> μm             | – IBAD/PLD | Y <sub>2</sub> O <sub>3</sub> particles | 40 um | <b>2 x 10</b> μm | 490 A/cm |
| JAPAN FACTORY                                |       |            |                    |                                 |                             |                        | TDCU -                       |                           |            | (native)                                |       |                  | 467 A/cm |
|  |       |            | <b>2.5 μm</b>      |                                 |                             | 40 μ                   | electroplated                | 420 A/cm                  |            |   |       |                  |          |
|  |       |            | •                  |                                 |                             |                        |                              | 405 A/cm                  |            |   |       |                  |          |
|  | 3 mm  |            | <b>3</b> μm        | 3 μm                            |                             | 👿 30 μm                | - 2 x 10 μm<br>electroplated | 590 A/cm                  |            |   |       |                  |          |
| 上海超导 <sup>™</sup><br>SHANGHAI SUPERCONDUCTOR |       | EuBCO      | CO<br>2 μm         | -<br>IBAD/PLD                   | BHO columns                 |                        |                              | 428 A/cm                  |            |   |       |                  |          |
|  | 4 mm  | m          |                    |                                 | (artificial)                | 50 μm                  |                              | 645 A/cm                  |            |   |       |                  |          |
|  |       |            | •                  | -                               |                             |                        |                              | 632 A/cm                  |            |   |       |                  |          |
| Scs4050-HM                                   | 4 mm  | YBCO       | <b>▼1.5</b> μm     | IBAD/MOCVD                      | BZO columns<br>(artificial) | <b>50</b> μm           | 2 x 5 μm<br>electroplated    | ▼ 148 A/cm                |            |   |       |                  |          |

|                     | Width | REBCO Type | REBCO<br>Thickness     | Deposition<br>Method | Pinning Type                            | Hastelloy<br>Thickness | Cu Stabilizer              | I <sub>c</sub> (77K,s.f.)  |                            |
|---------------------|-------|------------|------------------------|----------------------|---|------------------------|----------------------------|----------------------------|----------------------------|
|                     |       |            | <b>2.5 μm</b> IBAD/PLD |                      |   |                        | 2 x 40 μm<br>electroplated | 420 A/cm                   |                            |
|                     | 4 mm  |            |                        |                      |   |                        | -                          | -                          | 2 x 20 μm<br>electroplated |
| <b>F</b> Fuiikura   |       | EuBCO      |                        |                      | 50 μm                                   | 2 x 10                 | ▲ 650 A/cm                 |                            |                            |
|                     |       |            | •                      |                      | (artificial)                            |                        | 2 x 10 µIII                | 558 A/cm                   |                            |
|                     |       |            |                        |                      | -                                       |                        | 515 A/cm                   |                            |                            |
|                     | 2 mm  |            |                        |                      |   |                        | 2 x 20 μm<br>electroplated | 555 A/cm                   |                            |
|                     | 4 mm  |            |                        | <b>▲ 3.1</b> μm      |   |                        | <b>▲ 100</b> μm            | 2 x 20 μm<br>electroplated | 550 A/cm                   |
| // <b>F</b> FARADAY |       | VRCO       | <b>2.7</b> μm          |                      | Y <sub>2</sub> O <sub>3</sub> particles | 40 µm                  | 2 x 10 μm<br>electroplated | 490 A/cm                   |                            |
| JAPAN FACTORY       |       | IDCO       | <b>2.5</b> μm          | IDAD/PLD             | (native)                                |                        |                            | 467 A/cm                   |                            |
|                     |       |            |                        |                      |   |                        |                            | 420 A/cm                   |                            |
|                     |       |            | •                      |                      |   |                        |                            | 405 A/cm                   |                            |
|                     | 3 mm  |            | 3 μm                   |                      |   | <b>▼</b> 30 μm         | 2 x 10 μm                  | 590 A/cm                   |                            |
| 上海超导™               | 4 mm  | EuBCO      |                        | IBAD/PLD             | BHO columns                             |                        |                            | 428 A/cm                   |                            |
|                     |       |            | 2 µm                   |                      | (artificial)                            | 50 µm                  | electroplated              | 645 A/cm                   |                            |
|                     |       |            | •                      |                      |   |                        |                            | 632 A/cm                   |                            |
| SCS4050-HM          | 4 mm  | YBCO       | <b>▼ 1.5</b> µm        | IBAD/MOCVD           | BZO columns<br>(artificial)             | 50 μm                  | 2 x 5 μm<br>electroplated  | ▼ 148 A/cm                 |                            |

|  | Width       | REBCO Type | REBCO<br>Thickness | Deposition<br>Method | Pinning Type                | Hastelloy<br>Thickness | Cu Stabilizer              | I <sub>c</sub> (77K,s.f.) |          |   |          |  |          |
|--|-------------|------------|--------------------|----------------------|-----------------------------|------------------------|----------------------------|---------------------------|----------|---|----------|--|----------|
|  |             |            |                    |                      | BHO columns                 |                        | 2 x 40 μm<br>electroplated | 420 A/cm                  |          |   |          |  |          |
|  | 4 mm        |            |                    |                      |                             |                        | 2 x 20 μm<br>electroplated | 380 A/cm                  |          |   |          |  |          |
| <b>F</b> Fujikura                              |             | EuBCO      | <b>2.5 μm</b>      |                      |                             | <b>50 μm</b>           | 2 x 10 um                  | ▲ 650 A/cm                |          |   |          |  |          |
|  |             |            | •                  |                      | (artificial)                |                        | 2 X 10 µm                  | 558 A/cm                  |          |   |          |  |          |
|  |             |            |                    |                      |                             |                        | electroplated              | 515 A/cm                  |          |   |          |  |          |
|  | 2 mm        |            |                    |                      |                             |                        | 2 x 20 μm<br>electroplated | 555 A/cm                  |          |   |          |  |          |
|  | <b>4 mm</b> |            | <b>▲ 3.1 μm</b>    | IBAD/PLD             |                             | <b>▲ 100</b> μm        | 2 x 20 μm<br>electroplated | 550 A/cm                  |          |   |          |  |          |
| // <b>F</b> FARADAY                            |             | 4 mm       | 4 mm               | 4 mm                 | 1 100 100                   | 1 100 100              | VPCO                       | <b>2.7</b> μm             |          | Y <sub>2</sub> O <sub>3</sub> particles |          |  | 490 A/cm |
| JAPAN FACTORY                                  |             |            |                    |                      | TECO                        |                        |                            | (native)                  | 40 um    | <b>2 x 10 μm</b>                        | 467 A/cm |  |          |
|  |             |            | <b>2.5</b> μm      |                      |                             | 40 µm                  | electroplated              | 420 A/cm                  |          |   |          |  |          |
|  |             |            |                    |                      |                             |                        | 405 A/cm                   |                           |          |   |          |  |          |
|  | 3 mm        |            |                    | <b>3</b> μm          |                             |                        | 🔻 30 μm                    |                           | 590 A/cm |   |          |  |          |
| 上海超导™  |             | EuBCO<br>m | EuBCO<br>2 μm      |                      | BHO columns                 |                        | 2 x 10 μm                  | 428 A/cm                  |          |   |          |  |          |
|  | 4 mm        |            |                    |                      | (artificial)                | <b>50</b> μm           | electroplated              | 645 A/cm                  |          |   |          |  |          |
|  |             |            |                    |                      |                             |                        |                            | 632 A/cm                  |          |   |          |  |          |
| SuperPower<br>A Furukawa Company<br>SCS4050-HM | 4 mm        | YBCO       | <b>▼1.5</b> µm     | IBAD/MOCVD           | BZO columns<br>(artificial) | 50 μm                  | 2 x 5 μm<br>electroplated  | ▼ 148 A/cm                |          |   |          |  |          |

|                     | Width | REBCO Type | REBCO<br>Thickness | Deposition<br>Method  | Pinning Type                | Hastelloy<br>Thickness | Cu Stabilizer              | I <sub>c</sub> (77K,s.f.)  |   |       |                  |          |
|---------------------|-------|------------|--------------------|-----------------------|-----------------------------|------------------------|----------------------------|----------------------------|---|-------|------------------|----------|
|                     |       |            |                    |                       | PHO columns                 |                        | 2 x 40 μm<br>electroplated | 420 A/cm                   |   |       |                  |          |
|                     | 4 mm  | ı          |                    |                       |                             |                        | 2 x 20 μm<br>electroplate  | 2 x 20 μm<br>electroplated | 380 A/cm                                |       |                  |          |
| <b>F</b> Fujikura   |       | EuBCO      | <b>2.5</b> μm      | IBAD/PLD (artificial) | 50 μm                       | 2 x 10 um              | ▲ 650 A/cm                 |                            |   |       |                  |          |
|                     |       |            |                    | •                     |                             | (artificial)           | electroplated              | 558 A/cm                   |   |       |                  |          |
|                     |       |            |                    |                       |                             |                        | electroplated              | 515 A/cm                   |   |       |                  |          |
|                     | 2 mm  |            |                    |                       |                             |                        | 2 x 20 μm<br>electroplated | 555 A/cm                   |   |       |                  |          |
|                     | 4 mm  |            | <b>▲</b> 3.1 μm    |                       |                             | <b>▲ 100</b> μm        | 2 x 20 μm<br>electroplated | 550 A/cm                   |   |       |                  |          |
| // <b>F</b> FARADAY |       | 4 mm       | 4 mm               | 4 mm                  | 4 mm                        | VPCO                   | <b>2.7</b> μm              |                            | Y <sub>2</sub> O <sub>3</sub> particles |       |                  | 490 A/cm |
| JAPAN FACTORY       |       |            |                    |                       |                             | TBCO                   |                            | - IDAU/PLU                 | (native)                                | 40 um | <b>2 x 10</b> μm | 467 A/cm |
|                     |       |            | <b>2.5 μm</b>      |                       |                             | <b>40</b> μm           | electroplated              | 420 A/cm                   |   |       |                  |          |
|                     |       |            | •                  |                       |                             |                        |                            | 405 A/cm                   |   |       |                  |          |
|                     | 3 mm  |            | <b>3</b> μm        |                       |                             | ▼ 30 μm<br>50 μm       |                            | 590 A/cm                   |   |       |                  |          |
| ◆ 上海超导 <sup>™</sup> | 4 mm  | EuBCO      | EuBCO<br>2 μm      | IBAD/PLD              | BHO columns                 |                        | 2 x 10 μm                  | 428 A/cm                   |   |       |                  |          |
| ~<br>               |       | mm         |                    |                       | (artificial)                |                        | electroplated              | 645 A/cm                   |   |       |                  |          |
|                     |       |            |                    |                       |                             |                        |                            | 632 A/cm                   |   |       |                  |          |
| SCS4050-HM          | 4 mm  | YBCO       | <b>▼1.5</b> μm     | IBAD/MOCVD            | BZO columns<br>(artificial) | 50 μm                  | 2 x 5 μm<br>electroplated  | ▼ 148 A/cm                 |   |       |                  |          |

|   | Width       | REBCO Type | REBCO<br>Thickness | Deposition<br>Method | Pinning Type                      | Hastelloy<br>Thickness | Cu Stabilizer              | l <sub>c</sub> (77K,s.f.)  |               |  |   |  |  |          |
|---|-------------|------------|--------------------|----------------------|-----------------------------------|------------------------|----------------------------|----------------------------|---------------|--|---|--|--|----------|
|   |             |            | ) <b>2.5</b> μm ΙΕ |                      |                                   |                        | 2 x 40 μm<br>electroplated | 420 A/cm                   |               |  |   |  |  |          |
| _   | 4 mm        |            |                    |                      | 2<br>ele                          | PHO columns            |                            | 2 x 20 μm<br>electroplated | 380 A/cm      |  |   |  |  |          |
| 🗲 Fujikura  |             | EuBCO      |                    | IBAD/PLD             | (artificial) 50 μm                | 2 x 10 um              | ▲ 650 A/cm                 |                            |               |  |   |  |  |          |
| ,   |             |            |                    |                      | (41 011014)                       | (artificial)           | electroplated              | 558 A/cm                   |               |  |   |  |  |          |
|   |             | -          |                    |                      |                                   |                        |                            | 515 A/cm                   |               |  |   |  |  |          |
|   | <b>2</b> mm |            |                    |                      |                                   |                        | 2 x 20 μm<br>electroplated | 555 A/cm                   |               |  |   |  |  |          |
|   |             |            | <b>▲ 3.1 μm</b>    | _                    |                                   | <b>▲ 100 μm</b>        | 100 μm<br>electroplated    |                            |               |  |   |  |  |          |
| // <b>F</b> FARADAY                                 | <b>4 mm</b> | 4 mm       | 1 mm               | 1 mm                 | 1 mm                              | 1 mm                   | 1 mm                       | VRCO                       | <b>2.7</b> μm |  | Y <sub>2</sub> O <sub>3</sub> particles |  |  | 490 A/cm |
| JAPAN FACTORY                                       |             |            | ibco               |                      |                                   | (native)               | 40 um                      | 2 x 10 μm                  | 467 A/cm      |  |   |  |  |          |
|   |             |            | <b>2.5</b> μm      |                      |                                   | io pini                | electroplated              | 420 A/cm                   |               |  |   |  |  |          |
|   |             |            |                    |                      |                                   |                        |                            |                            | 405 A/cm      |  |   |  |  |          |
|   | 3 mm        |            | 3 μm               |                      |                                   | 🔻 30 μm                | 2 x 10 μm<br>electroplated | 590 A/cm                   |               |  |   |  |  |          |
| 上海超导 <sup>™</sup>                                   |             | EuBCO      |                    | -<br>IBAD/PLD        | BHO columns<br>(artificial) 50 μm |                        |                            | 428 A/cm                   |               |  |   |  |  |          |
|   | 4 mm        | m          | <b>2</b> μm        | -                    |                                   | <b>50</b> μm           |                            | 645 A/cm                   |               |  |   |  |  |          |
|   |             |            |                    |                      |                                   |                        |                            | 632 A/cm                   |               |  |   |  |  |          |
| SuperPower Inc.<br>A Furukawa Company<br>SCS4050-HM | 4 mm        | YBCO       | <b>▼1.5</b> µm     | IBAD/MOCVD           | BZO columns<br>(artificial)       | 50 μm                  | 2 x 5 μm<br>electroplated  | ▼ 148 A/cm                 |               |  |   |  |  |          |

В

#### **Comparison of the performance:** I<sub>c</sub> / width The best performing tapes from each manufacturer



The highest I<sub>c</sub> at 4.2 K, 19 T is reached with the tapes having the highest and the lowest I<sub>c</sub>(77 K, s.f.)



#### **Evolution of the performance: non-Cu J<sub>c</sub>**



DOI: <u>10.3390/instruments5010008</u>

#### **Batch-to-batch variability of REBCO performance** I<sub>c</sub> distributions of tapes produced for fusion and for the 32 T magnet at MagLab



A large variability of the performance at low temperature/high field, about  $\pm$  30%, is observed for a given I<sub>c</sub> at 77 K, self-field

## (Non-)uniformity of I<sub>c</sub> over the length



A variation of  $I_c(77 \text{ K,sf})$  by  $\pm 10\%$  along the length is common, but larger drops may occur locally

F. Gömöry, et al., SuST <u>36</u> (2023) 054001 DOI: <u>10.1088/1361-6668/acb73f</u>

#### **Comparison of the performance:** I<sub>c</sub> / width Batch-to-batch variability in the material procured for MuCol

![](_page_16_Figure_2.jpeg)

![](_page_16_Figure_3.jpeg)

## Scaling of the pinning force: $f_p \propto b^p (1-b)^q$

Normalized pinning force vs B / B<sub>peak</sub> from magnetic and transport measurements

![](_page_17_Figure_3.jpeg)

**Pinning: Artificial - BHO columns** 

CS et al., Supercond. Sci. Tech. 37 (2024) 115013 DOI: 10.1088/1361-6668/ad7f95

B

## Scaling of the pinning force: $f_p \propto b^p (1-b)^q$

Normalized pinning force vs B / B<sub>peak</sub> from magnetic and transport measurements

![](_page_18_Figure_3.jpeg)

CS *et al.,* Supercond. Sci. Tech. <u>37</u> (2024) 115013 DOI: <u>10.1088/1361-6668/ad7f95</u>

B

# Scaling of the pinning force: $f_p \propto b^p (1-b)^q$

![](_page_19_Figure_2.jpeg)

#### There is a robust scaling behavior in perpendicular field ...

#### ... but REBCO anisotropy adds a layer of complexity

#### **Measurement campaign on the angular dependence of I** Results on full-width tapes and microbridges

![](_page_21_Figure_2.jpeg)

![](_page_22_Figure_1.jpeg)

Good match of the results when comparing  $I_c/I_c$  (77 K, s.f.)

In both experiments I<sub>c</sub>(77 K, s.f.) is measured on the actual sample mounted on the probe

R. Babouche's poster, Wednesday @ 12:30

#### $I_c(B,\theta,T)$ does not exhibit universal behaviour Comparison of the results on tapes from three manufacturers

![](_page_23_Figure_2.jpeg)

R. Babouche's poster, Wednesday @ 12:30

# Outline

- A short introduction to the Muon Collider magnets
- MuCol procurement of REBCO coated conductors
  - Conductor specs for the HF and UHF solenoids
  - Transport I<sub>c</sub> measurements and scaling relations
  - Results of the measurement campaign on the angular dependence of I<sub>c</sub>
  - Delamination strength under I x B force
- Conclusions

#### **Delamination strength is very low...** A direct measurement of conductor degradation under I x B force

![](_page_25_Figure_2.jpeg)

**Stress profile within REBCO when current increases** 

## Conclusions

- The I<sub>c</sub> values at low temperature/high field of commercial REBCO tapes in perpendicular orientation are quite close. And pinning forces scale reasonably well over a wide range of temperatures.
- Things change when we examine the angular dependence of I<sub>c</sub>. It is strongly influenced by process, composition and pinning landscape.
- Electromagnetic Delamination Strength (EDS) experiments show that REBCO tapes cannot sustain transverse tensile tension. The procedure for EDS tests is being consolidated and more data will be shared soon.
- Unlike the traditional paradigm of round wires with transposed filaments, REBCO tapes bring challenges and opportunities. R&D efforts can mitigate some issues, but rather than waiting for the perfect material, we must continue to harness and capitalize on the strengths of current REBCO tapes and keep up the momentum in advancing the technology.
- In the case of MuCol, where high-performance magnets are crucial, efforts should be directed toward exploiting degrees of freedom in the other machine's subsystems to compensate for material limitations. This attitude should be embraced as a general approach.

![](_page_27_Picture_1.jpeg)

![](_page_27_Picture_2.jpeg)

![](_page_27_Picture_3.jpeg)

# Thank you for the attention !

Carmine SENATORE carmine.senatore@unige.ch http://supra.unige.ch

![](_page_27_Picture_6.jpeg)

Federal Department of Economic Affairs, Education and Research EAER State Secretariat for Education, Research and Innovation SERI

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